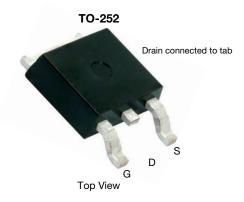
## SQD40031EL

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**Vishay Siliconix** 

# Automotive P-Channel 30 V (D-S) 175 °C MOSFET

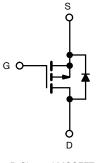


PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-30			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.00320			
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.00520			
I <sub>D</sub> (A)	-100			
Configuration	Single			
Package	TO-252			

### **FEATURES**

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 %  $R_g$  and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>GS</b> (T <sub>C</sub> = 25 °C, unles	s otherwise noted	)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	-30	V
Gate-source voltage		V <sub>GS</sub>	± 20	v
Continuous drain current	$T_{C} = 25 \ ^{\circ}C \ ^{a}$	- I <sub>D</sub>	-100	
	T <sub>C</sub> = 125 °C		-94	
Continuous source current (diode conduction) <sup>a</sup>		I <sub>S</sub>	-100	А
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	-300	
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	-41	
Single pulse avalanche energy	L = 0.1 MH	E <sub>AS</sub>	84	mJ
Maximum power dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	D	136	W
waximum power dissipation ~	T <sub>C</sub> = 125 °C	P <sub>D</sub>	45	VV
Operating junction and storage temperatur	re range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	50	°C/W	
Junction-to-case (drain)		R <sub>thJC</sub>	1.1	0/10	

#### Notes

- a. Package limited
- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = -250 μA	-30	-	-	v
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$		-1.5	-2.0	-2.5	v
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = -30 V	-	-	-1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS}$ = -30 V, $T_{J}$ = 125 °C	-	-	-50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = -30 V, T <sub>J</sub> = 175 °C	-	-	-250	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = -10 V$	$V_{DS} \ge -5 V$	-50	-	-	А
		$V_{GS} = -10 V$	I <sub>D</sub> = -30 A	-	0.00263	0.00320	
Drain-source on-state resistance <sup>a</sup>	в	$V_{GS} = -10 V$	I <sub>D</sub> = -30 A, T <sub>J</sub> = 125 °C	-	-	0.00438	Ω
	R <sub>DS(on)</sub>	$V_{GS} = -10 V$	I <sub>D</sub> = -30 A, T <sub>J</sub> = 175 °C	-	-	0.00502	
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -25 A	-	0.00425	0.00520	
Forward transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= -15 V, I <sub>D</sub> = 30 A	-	98	-	S
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>			-	11 085	15 000	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = -25 V, f = 1 MHz	-	1342	1900	pF
Reverse transfer capacitance	C <sub>rss</sub>	-		-	1181	1600	
Total Gate Charge <sup>c</sup>	Qg			-	186	280	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = -10 V$	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -100 \text{ A}$	-	28	-	nC
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	28	-	
Gate resistance	Rg		f = 1 MHz	1.7	3.5	5.3	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	16	25	
Rise time <sup>c</sup>	tr	$V_{DD}$ = -15 V, $R_L$ = 0.2 $\Omega$		-	204	310	200
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	I <sub>D</sub> ≅ -100 A,	$V_{GEN}$ = -10 V, $R_g$ = 1 $\Omega$	-	126	190	ns
Fall time <sup>c</sup>	t <sub>f</sub>			-	72	110	
Source-Drain Diode Ratings and Charac	teristics <sup>b</sup>						
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	-300	А
Forward voltage	$V_{SD}$	I <sub>F</sub> =	-30 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.5	V
Body diode reverse recovery time	t <sub>rr</sub>			-	66	135	ns
Body diode reverse recovery charge	Q <sub>rr</sub>		A di/dt 100 A /··-	-	100	200	nC
Reverse recovery fall time	t <sub>a</sub>	$I_F = -40$	A, di/dt = 100 A/µs	-	31	-	
Reverse recovery rise time	t <sub>b</sub>	1		-	35	-	ns
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-3.4	-	А

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

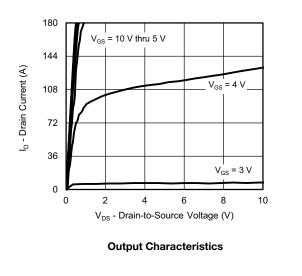
b. Guaranteed by design, not subject to production testing

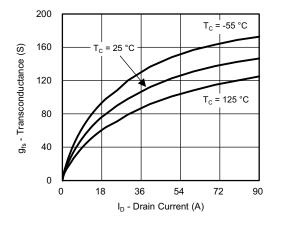
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

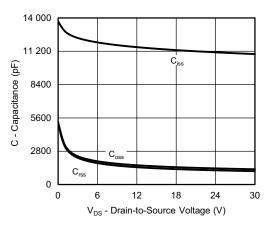


## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

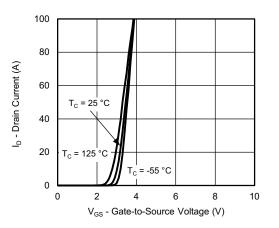




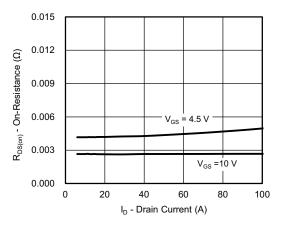
Transconductance



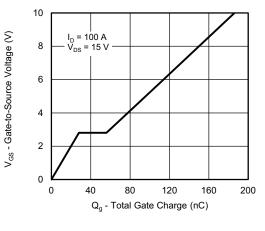
### Capacitance



**Transfer Characteristics** 



**On-Resistance vs. Drain Current** 



Gate Charge

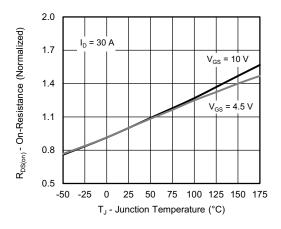
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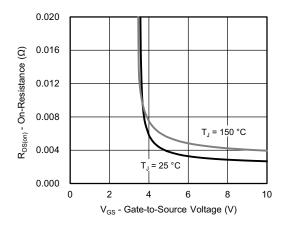
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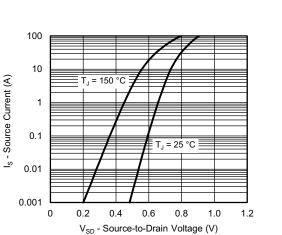
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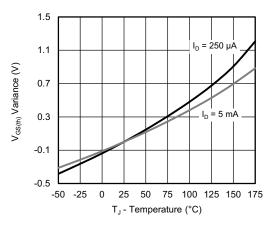
**On-Resistance vs. Junction Temperature** 



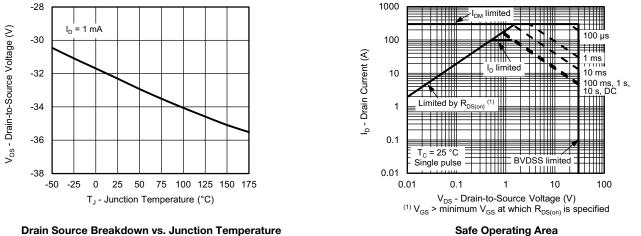
**On-Resistance vs. Gate-to-Source Voltage** 



Source Drain Diode Forward Voltage



**Threshold Voltage** 



Drain Source Breakdown vs. Junction Temperature

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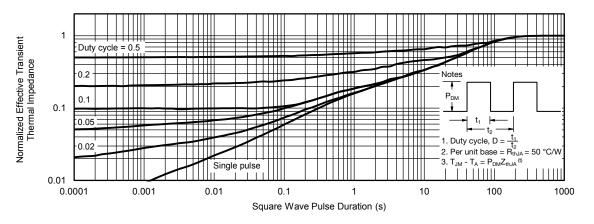
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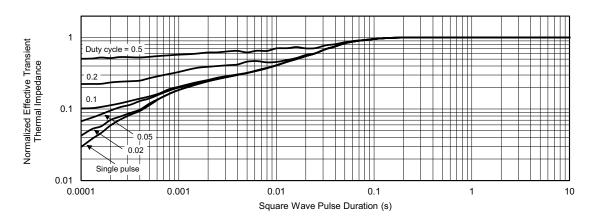
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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



#### Normalized Thermal Transient Impedance, Junction-to-Case

### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to- Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

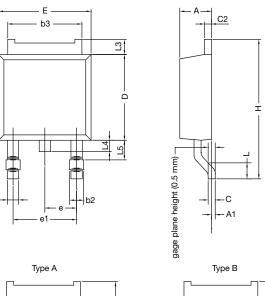
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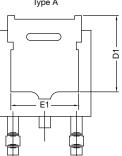
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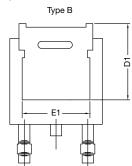


TO-252AA Case Outline





b



MIN.   2.18   -   0.64   0.76   4.95   0.46   0.46   5.97   4.10	MAX. 2.38 0.127 0.88 1.14 5.46 0.61 0.89 6.22	MIN. 0.086 - 0.025 0.030 0.195 0.018 0.018 0.235	MAX. 0.094 0.005 0.035 0.045 0.215 0.024 0.035 0.245
- 0.64 0.76 4.95 0.46 0.46 5.97 0.64 0.65 0.65 0.65 0.65 0.65 0.65 0.65 0.65	0.127 0.88 1.14 5.46 0.61 0.89 6.22	- 0.025 0.030 0.195 0.018 0.018	0.005 0.035 0.045 0.215 0.024 0.035
0.64     0.76       4.95     0.46       0.46     0.46       5.97     0.46	0.88 1.14 5.46 0.61 0.89 6.22	0.025 0.030 0.195 0.018 0.018	0.035 0.045 0.215 0.024 0.035
0.76 4.95 0.46 0.46 5.97	1.14 5.46 0.61 0.89 6.22	0.030 0.195 0.018 0.018	0.045 0.215 0.024 0.035
4.95 0.46 0.46 5.97	5.46 0.61 0.89 6.22	0.195 0.018 0.018	0.215 0.024 0.035
0.46 0.46 5.97	0.61 0.89 6.22	0.018 0.018	0.024 0.035
0.46 5.97	0.89 6.22	0.018	0.035
5.97	6.22		
		0.235	0.245
4.10			0.240
	-	0.161	-
6.35	6.73	0.250	0.265
4.32	-	0.170	-
9.40	10.41	0.370	0.410
2.28 BSC		0.090	BSC
4.56 BSC		0.180	BSC
1.40	1.78	0.055	0.070
0.89	1.27	0.035	0.050
-	1.02	-	0.040
1.01	1.52	0.040	0.060
	4.32 9.40 2.28 B 4.56 B 1.40 0.89 -	4.32     -       9.40     10.41       2.28 BSC     4.56 BSC       1.40     1.78       0.89     1.27       -     1.02	4.32     -     0.170       9.40     10.41     0.370       2.28 BSC     0.090       4.56 BSC     0.180       1.40     1.78     0.055       0.89     1.27     0.035       -     1.02     -

#### Notes

• Dimension L3 is for reference only

• Dimension D1 and E1 on type A and B is the same



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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